

CALENDAR

Upcoming: April 21–25 MRS Spring Meeting, MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the January 2003 MRS BULLETIN for March 2003 Calendar entries.

APRIL 2003

2–4 5th Intl. Conf. on Simulations in Biomedicine, *Ljubljana, Slovenia*. Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk.

5–8 2nd Intl. Conf. on New Biomedical Materials, *Cardiff, Wales, UK*. P.I. Haris, School of Molecular Sciences, De Montfort Univ., The Gateway, Leicester LE1 9BH, UK; 44-116-250-6306; fax 44-116-257-7287; e-mail pharis@dmu.ac.uk; www.appsci.dmu.ac.uk/biomat/MainPage.htm.

7–10 12th Intl. Conf. on Deformation, Yield, and Fracture of Polymers, *Cambridge, UK*. M. Boyce, Conf. and Events, IOM Communications; 44-20-7451-7303; fax 44-20-7839-2289.

8–10 84th AWS Annual Meeting, *Detroit, MI*. D. Gonzalez, ASW Professional Program Coordinator, American Welding Society, 550 N.W. LeJeune Rd., Miami, FL 33126; 305-443-9353; fax 305-443-7559; e-mail dorcas@aws.org; www.aws.org.

9–11 Intl. Workshop on Hard Synchrotron X-Rays for Texture and Strain Analysis, *Hamburg, Germany*. J. Homeyer, Industrial Servicegroup, Hamburger Synchrotronstrahlungslabor, Deutsches Elektronen-Synchrotron, D-22603 Hamburg, Germany; 49-40-8998-1715; fax 49-40-8998-4475; e-mail jens.homeyer@desy.de; www-hasyllab.desy.de/conferences/workshop.

16–18 10th Symposium on Photomask and NGL Mask Technology, *Kanagawa, Japan*. Photomask Japan Secretariat, c/o Business Ctr. for Academic Societies Japan, 5-16-9 Honkomagome, Bunkyo-ku, Tokyo 113-8622, Japan; 81-3-5814-5800; fax 81-3-5814-5823; e-mail pmj@bcasj.or.jp; www.bcasj.or.jp/pmj.

16–18 Intl. Conf. on Electronic Packaging, *Tokyo, Japan*. IMAPS, 611 2nd St., N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

21–25 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org.

27–30 105th ACeRS Annual Meeting, *Nashville, TN*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

27–30 ISS Technical Conf., *Indianapolis, IN*. D. Kanagy, Iron & Steel Society, 186 Thorn Hill Rd., Warrendale, PA 15086; 724-776-1535; fax 724-776-5111; www.issstech.info.

27–1 STLE Annual Meeting, *New York, NY*. Society of Tribologists and Lubrication Engineers, 840 Busse Hwy., Park Ridge, IL 60068-2376; 847-825-5536; fax 847-825-1456; www.stle.org.

27–2 14th European Conf. on Chemical Vapor Deposition, *Paris, France*. M. Swihart, 716-645-2911; fax 716-645-3822; e-mail swihart@eng.buffalo.edu. Endorsed.

27–2 203rd Meeting of the Electrochemical Society, *Paris, France*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

28–2 Intl. Conf. on Metallurgical Coatings and Thin Films, *San Diego, CA*. M.S. Gray, ICMCTF-2003, Ste. 136, 14001-C St. Germain Dr., Centreville, VA 20121; 703-266-3287; fax 703-968-8877; e-mail icmctf@mindspring.com; www.av.org/icmctf/icmctf.html.

MAY 2003

3–8 46th Annual SVC Technical Conf., *San Francisco, CA*. Society of Vacuum Coaters, 71 Pinon Hill Place, N.E., Albuquerque, NM 87122-1914; 505-856-7188; fax: 505-856-6716; e-mail svcinfo@svc.org; www.svc.org.

4–8 ▼ Society of Plastics Engineers Annual Technical Conf., *Nashville, TN*. Intl. Headquarters, Society of Plastics Engineers, 14 Fairfield Dr., Brookfield, CT 06804; 203-775-0471; fax 203-775-8490; e-mail antec@4spe.org; www.antec.ws.

4–9 ▼ 8th Intl. Symposium on Electrochemical Methods in Corrosion Research, *Nieuwpoort, Belgium*. J. Vereecken, Vrije Univ. Brussel, Vakgroep Metallurgie, Elektrochemie en Materialenkennis; Pleinlaan 2, 1050 Brussels, Belgium; 32-2-629-3254; fax 32-2-629-3200; e-mail jvereeck@vub.ac.be; dtwws1.vub.ac.be/meta/

11–15 SAMPE 2003, *Long Beach, CA*. D. Weaver, SAMPE Business Office, P.O. Box 2459, Covina, CA 91722; 626-331-0616; fax 626-332-8929; e-mail dweaveribo@cs.com; www.sampe.org.

12–14 11th Intl. Conf. on Computational Methods and Experimental Measurements, *Halkidiki, Greece*. Conf. Secretariat, CMEM 2003, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail conferences@wessex.ac.uk; www.wessex.ac.uk/conferences.

13–15 11th Intl. SENSOR Trade Fair and Conf., *Nuremberg, Germany*. AMA Service GmbH, Von-Münchhausen-Strasse 49, 31515 Wunstorf, Germany; 49-5033-9639-0; fax 49-5033-1056; e-mail info@sensorfairs.de; www.sensorfairs.de.

13–15 ▼ IMAPS Advanced Technology Workshop on Packaging Copper/Low-κ Semiconductors, *San Diego, CA*. IMAPS, 611 2nd St., N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; imaps@imaps.org; www.imaps.org.

13–15 ▼ Space-Based EO/IR Surveillance Technology Conf., *Albuquerque, NM*. S. Blankenship, Space Technology Advanced Research Ctr., Georgia Inst. of Technology, 2015 Yale Blvd. S.E., Albuquerque, NM 87106; 505-246-0058; e-mail sam.blankenship@gtri.gatech.edu; www.star.gatech.edu.

18–22 3rd Intl. Symposium on Aluminum Surface Science and Technology, *Bonn, Germany*. B. Kernig, VAW Research and Development, P.O. Box 2468, 53014 Bonn, Germany; 49-228-552-2639; fax 49-228-552-2446.

18–23 ▼ 4th Intl. Conf. on Intelligent Processing and Manufacturing of Materials, *Sendai, Japan*. IPMM-2003, J. Isoda, IMR, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 980-8577, Japan; e-mail ipmm@imr.edu; www-lab.imr.tohoku.ac.jp/~ipmm/.

18–23 Gordon Research Conf. on Organic Thin Films, *Il Ciocco, Italy*. Gero Decher, Institute Charles Sadron (CRM-EAHP), CNRS & ULP, 6 Rue Boussingault, Strasbourg, Cedex F-67083, France; e-mail decher@ics.u-strasbg.fr; www.grc.org.

18–23 Society for Information Display 2003 (SID 2003), *Baltimore, MD*. Society for Information Display Headquarters, 610 S. 2nd Street, San Jose, CA 95112-4006, USA; tel. 408-977-1013; fax 408-977-1531; e-mail conferences@sid.org; www.sid.org.

19–21 SPIE Intl. Symposium on Microtechnologies for the New Millennium 2003, *Gran Canaria, Spain*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/info/emt.

23–28 ▼ Conf. on Interfaces and Colloidal Systems: Structure and Dynamics of Polymers and Colloidal Systems, *Giens, France*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

25–29 9th Intl. Conf. on the Mechanical Behavior of Materials, *Geneva, Switzerland*. Conf. Secretariat, ICM9, P.O. Box 50006, Tel Aviv 61500, Israel; 972-3-514-0014; fax 972-3-514-0077; e-mail icm9@kenes.com; www.kenes.com/icm9.

25–30 5th Intl. Conf. on Nitride Semiconductors, *Nara, Japan*. K. Hiramatsu, Dept. of Electrical and Electronic Engineering, Mie Univ., 1515 Kamihama, Tsu 514-8507, Mie, Japan; phone and fax 81-59-231-9694; e-mail hiramatsu@elec.mie-u.ac.jp.

25–30 7th Intl. Conf. on Materials and Mechanisms of Superconductivity and High Temperature Superconductors, *Rio de Janeiro, Brazil*. Conf. Secretariat, Congresso do Brasil Ltda., Av. Presidente Wilson, 164 9th Floor, 20030-020, Rio de Janeiro, RJ, Brasil; 55-21-3974-2001; fax 55-21-2509-1492; e-mail m2srio@congreg.com.br; www.m2srio.cbpf.br.

26–28 ▼ Intl. Conf. on Nano-Micro-Interfaces, *Berlin, Germany*. NAMIX Conf. Office; fax 49-731-5031049; www.namix-conference.de.

26–29 4th Intl. Conf. on Physical and Numerical Simulation of Materials Processing, *Shanghai, China*. J. Niu, Box 436, School of Materials Science and Engineering, Harbin Inst. of Technology, Harbin 150001, P.R. China; 86-451-641-4279; fax 86-451-622-1048.

27–30 4th Intl. Conf. on Conveying and Handling of Particulate Solids, *Budapest, Hungary*. 4th CHoPS Secretariat, KE Research Inst. of Chemical and Process Engineering, Veszprém, P.O. Box 125, H-8021 Hungary; 36-88-425-206; fax 36-88-424-424; e-mail szept@mukki.richem.hu; www.partconf2003.hu.

28–30 5th Intl. Conf. on Marine Technology and Transportation, *Szczecin, Poland*. Conf. Secretariat, Marine 2003, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail shobbs@wessex.ac.uk; www.wessex.ac.uk/conferences/2003/marine03.

31–4 ▼ Jacques Monod Conf. on New In Vivo Imaging Modalities for Molecular Biology, Cell Biology, and Physiology, *Roscoff, France*. Conf. Secretariat, Jacques Monod, CNRS, Dept. Sciences de la Vie, 3 rue Michel-Ange, 75794 Paris Cedex 16, France; 33-247-282-611; fax 33-247-278-756; e-mail conf.monod@cns-dir.fr; www.cns.fr/SDV/cjm.html.

31–5 ▼ Molecular Crystal Engineering: EuroConf on Design and Preparation of Molecular Materials, *Acquafredda di Maratea, Italy*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

JUNE 2003

1–3 ▼ Symposium on Micro-tribology—Tribology in Microsystems, *Neuchâtel, Switzerland*. H. Haefke, CSEM Swiss Ctr. for Electronics and Microtechnology, Rue Jaquet-Droz 1, CH-2007, Neuchâtel, Switzerland; 41-32-720-5269; fax 41-32-720-5740; e-mail henry.haefke@csem.ch; www.csem.ch.

1–4 49th Intl. Conf. on Analytical Sciences and Spectroscopy, *Ottawa, Ontario, Canada*. N. De Silva, Dept. of Chemistry, Carleton Univ., Ottawa, ON K1S 4B6, Canada; 613-520-2600; fax 613-520-3749; e-mail ndsilva@ccs.carleton.ca.

24-29 ▼ 12th Intl. Workshop on Sol-Gel Science and Technology, *Sydney, Australia*. Sol-Gel '03 Conf. Secretariat, ICMS Pty Ltd., 379 Kent St., Sydney NSW 2000, Australia; 61-2-9290-3366; fax 61-2-9290-2444; e-mail sol-gel@icms.com.au; www.icms.com.au/sol-gel.

31-5 ▼ 12th Intl. Conf. on Radiation Effects in Insulators, *Gramado, RS, Brazil*. Conf. Secretariat, Inst. de Física, Univ. Federal do Rio Grande do Sul, Caixa Postal 15051, 91501-970 Porto Alegre, RS, Brazil; 55-51-2-3116-6510; fax 55-51-3316-6323; e-mail rei-12@if.ufrgs.br; www.if.ufrgs.br/rei-12.

31-5 16th Intl. Mass Spectrometry Society Conf., *Edinburgh, Scotland*. A. Upton, Secretary to the 16th IMSC Organizing Committee, Orchard House, 172 High Street Yelling, St. Neots, PE19 6SD, UK; 44-1480-88-0069; fax 44-1480-88-059; e-mail imsc@edinburgh@btinternet.com; www.imsc-edinburgh2003.com.

SEPTEMBER 2003

1-3 Conf. on Bragg Gratings, Photosensitivity, and Poling in Glass Waveguides, *Monterey, CA*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings.

1-5 European Congress on Advanced Materials and Processes, *Lausanne, Switzerland*. Euromat 2003 Congress Office, c/o Deutsche Gesellschaft für Materialkunde, Hamburger Allee 26, 60486 Frankfurt, Germany; 49-69-7917-747; fax 49-69-7917-733; e-mail euromat@fems.org; www.euromat2003.fems.org.

5-10 ▼ Molecular Liquids: Routes from Local Order to Large-Scale Cooperativity EuroConf., *Castelvecchio Pascoli, Italy*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

5-10 ▼ NMR in Molecular Biology: EuroConf. on Structural Genomics, *Obernai, France*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

6-11 ▼ Conf. on Fundamental Problems of Mesoscopic Physics: Interactions and Decoherence, *Granada, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

7-12 ▼ 2nd Intl. Workshop on Flow and Fracture of Advanced Glasses, *Trento, Italy*. FFAG Workshop Secretariat, c/o G.D. Sorarù, Dept. Materials Engineering, Univ. of Trento, Via Mesiano 77, 38050 Trento, Italy; 39-461-882454; fax 39-461-881945; e-mail soraru@ing.unitn.it; www.ing.unitn.it/dim/convegna/2003/FFAG.

8-10 Materials and Processes for Medical Devices Conf., *Anaheim, CA*. ASM Intl., Conf. Administrator, Medical Devices Event, Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org/meddevices.

12-14 Conf. on Controlled Polymer Architectures—From Micro to Meso Scale, *Durham, UK*. Royal Society of Chemistry, Burlington House, Piccadilly, London W1J 0BA, UK; 44-20-7437-8656; fax 44-20-7734-1227; e-mail conferences@rsc.org; www.rsc.org/lap/conf/contpolymer.htm.

13-18 ▼ Bose-Einstein Condensation: EuroConf. on the New Trends in Physics of Quantum Gases, *San Feliu de Guixols, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

14-18 6th European Conf. on Applied Superconductivity EUCAS, *Sorrento, Italy*. Fax 39-81-239-1821; e-mail eucas2003@unina.it; www.eucas2003.it/index.php.

15-18 ▼ ASM Intl. Surface Engineering Congress, with 22nd ASM Heat Treating Conf. and North American Die Casting Assoc. Congress, *Indianapolis, IN*. Conf. Administrator, Surface Engineering Congress, ASM Intl., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org/surface.

15-19 ▼ E-MRS Fall Meeting, *Warsaw, Poland*. E-MRS Fall Meeting Conf. Secretariat, High Pressure Research Ctr., Sokolowska 29, 01-142 Warszawa, Poland; 48-22-632-4302; fax 48-22-632-4218; e-mail emrs@unipress.waw.pl; www-emrs.c-strasbourg.fr. **E-MRS.**

16-19 European Metallurgical Conf., *Hanover, Germany*. EMC Organizing Committee, GDMB, Paul-Ernst-Str. 10, D-38678 Clausthal-Zellerfeld, Germany; 49-5323-93790; fax 49-5323-937-937.

17-18 ▼ Intl. Conf. on Nanotechnology and PM2: Scientific Challenges and Commercial Opportunities, *Providence, RI*. S. Leatherman, Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

20-25 ▼ Surface Plasmon Photonics: EuroConf. on Nano-Optics, *Granada, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

22-24 31st Annual NATAS Conf., *Albuquerque, NM*. T. Ramotowski, NATAS 2003 Conf. Technical Program Chair, North American Thermal Analysis Society, Naval Undersea Warfare Center (Code 2132), 1176 Howell St., Newport, RI 02841; 401-832-5111; fax 401-832-6401; e-mail ramotowskts@npt.nuwc.navy.mil; www.natasinfo.org.

22-25 Intl. Conf. on Erosive and Abrasive Wear II, *Cambridge, UK*. N. Woods, Elsevier Science Ltd., The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843297; fax 44-1865-843958; e-mail n.woods@elsevier.com; www.iceaw.com.

22-26 Cryogenic Engineering Conf., and Intl. Cryogenic Materials Conf., *Anchorage, Alaska*. Centennial Conferences, 801 Main St., Ste. 010, Louisville, CO 80027; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.centennialconferences.com.

24-26 8th Grove Fuel Cell Symposium and Building Fuel Cell Industries, *London, UK*. S. Wilkinson, Conf. Secretariat, Elsevier Science Ltd., The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843691; fax 44-1865-843958; e-mail sm.wilkinson@elsevier.com; www.grovetfuelcell.com.

25-26 ▼ 11th Intl. Activated Carbon Conf., *Pittsburgh, PA*. H. Nowicki, Conf. Chairperson; Professional Analytical and Consulting Services, 409 Meade Dr., Coraopolis, PA 15108; 724-457-6576; fax 724-457-1214; e-mail HNpacs@aol.com; www.pacslabs.com.

27-2 ▼ Quantum Optics: EuroConf. on Cavity QED and Quantum Fluctuations, *Granada, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

28-2 ▼ 35th Intl. SAMPE Technical Conf., *Dayton, OH*. D. Weaver, SAMPE Business Office, P.O. Box 2459, Covina, CA 91722-8459; 626-331-0616; fax 626-332-8929; e-mail dweaver@cs.com; www.sampe.org.

29-2 ▼ 10th Intl. Conf. on Defects: Recognition, Imaging, and Physics of Semiconductors, *Batz-sur-Mer, France*. D. Rocher, Lab. des Plasmas et des Couches Minces, Inst. des Matériaux Jean Rouxel, UMR CNRS 6502, 2 rue de la Houssinière, BP 32229, 44322 Nantes Cedex 3, France; 33-2-4037-3954; fax 33-2-4037-3959; e-mail regdrip10@cnrs-imm.fr; www.cnrs-imm.fr/drip10.htm.

30-3 ▼ Conf. on Optical Systems Design, *St. Etienne, France*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org/info/eod.

OCTOBER 2003

4-9 ▼ Conf. on Fundamental Aspects of Surface Science: Manufacture and Properties of Structures with Reduced Dimensionality, *Kerkrade, The Netherlands*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

5-9 87th OSA Annual Meeting and Laser Science Conf., *Tucson, AZ*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings.

7-12 ▼ Electromagnetic Interactions with Nucleons and Neutrons: EuroConf. on Hadron Structure Viewed with Electromagnetic Probes, *Santorini, Greece*. European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-3-8876-7100; fax 33-3-8837-0532; e-mail euresco@esf.org; www.esf.org/euresco.

8-13 8th IUMRS International Conference on Advanced Materials, *Yokohama, Japan*. Prof. Atsushi Suzuki, and Ms. Kyoko Yoshimi, c/o Prof. A. Suzuki's Laboratory, Faculty of Environment and Information Sciences & Materials Science Department, Yokohama National University, 79-7 Tokiwadai, Hodogaya-ku, Yokohama 240-8501, Japan; tel./fax 81-45-339-4305; e-mail icam2003@ynu.ac.jp; www.mrs-j.org. **IUMRS/MRS-J.**

12-14 19th Annual Conf. of the Intl. Titanium Assoc., *Monterey, CA*. ITA, 350 Interlocken Blvd., Ste. 390, Broomfield, CO 80021-3485; 303-404-2221; fax 303-404-9111; e-mail conference@titanium.org; www.titanium.org.

12-16 ▼ 3rd Intl. Conf. on Bulk Metallic Glasses (Bulk Amorphous Alloys), *Beijing, China*. W. H. Wang, Inst. of Physics, Chinese Academy of Sciences, P.O. Box 603, Beijing 100080, P.R. China; 86-10-8264-9198; fax 86-10-8264-0223; e-mail Whw@aphy.iphy.ac.cn; www.iphy.ac.cn.

12-17 204th Meeting of the Electrochemical Society, *Orlando, FL*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

13-16 ▼ ASM Materials Solutions Conf. and ASNT Fall Meeting, *Pittsburgh, PA*. ASM Intl., Materials Park, OH 44073-0002; 440-338-5151; fax 440-338-4634; e-mail cust-srv@asminternational.org; www.asminternational.org/materialsolutions.

15-18 Intl. Meeting on Applied Physics, *Badajoz, Spain*. www.formatex.org/aphys2003/aphys2003.htm.

19-22 55th Pacific Coast Regional and Basic Science Division Meeting of the ACerS, *Oakland, CA*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

19-22 UNITECR Congress—8th Biennial Worldwide Congress on Refractories, *Osaka, Japan*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

20-23 ▼ 19th Annual Intl. Conf. on Contaminated Soils, Sediments, and Water, *Amherst, MA*. D. Leonard, Environmental Health Sciences, N344 Morrill, Univ. of Massachusetts, Amherst, MA 01003; 413-545-1239; fax 413-545-4692; e-mail dleonard@scholp.umass.edu; www.UJMassSoils.com.

21-23 ▼ Advanced Metallization Conference (AMC) 2003, *Montreal, Canada*. UC Berkeley Extension, Continuing Education in Engineering, 1995 University Avenue, Berkeley, CA 94720, USA; 510 642-4151; fax 510 642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metal/.

23-24 ▼ 10th Sampling and On-Site Analysis Conf., *Pittsburgh, PA*. H. Nowicki, Conf. Chairperson; Professional Analytical and Consulting Services, 409 Meade Dr., Coraopolis, PA 15108; 724-457-6576; fax 724-457-1214; e-mail HNpacs@aol.com; www.pacslabs.com.

NOVEMBER 2003

3-7 50th AVS Intl. Symposium, *Baltimore, MD*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@avs.org; www.avs.org.

3-8 3rd Intl. Symposium on Slow Dynamics in Complex Systems, *Sendai, Japan*. M. Tokuyama, Inst. of Fluid Science, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 980-8577, Japan; phone and fax 81-22-217-5327; e-mail tokuyama@ifs.tohoku.ac.jp; www.ifs.tohoku.ac.jp/slow-dynamics.

5-7 Intl. Conf. on Materials Characterization, *Santa Fe, NM*. Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk.

9-12 TMS Fall Meeting, *Chicago, IL*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org.

16-20 7th Intl. Conf. on Atomically Controlled Surfaces, Interfaces, and Nanostructures, *Nara, Japan*. M. Katayama, Dept. of Electronic Engineering, Graduate School of Engineering, Osaka Univ., Ste. 565-0871, Osaka, Japan; 81-6-6879-7776; fax 81-6-6879-7780; e-mail acsin7@ele.eng.osaka-u.ac.jp; www.ele.eng.osaka-u.ac.jp/acsin7.

16-21 ▼ Conf. on Micro-Mechanical Properties of Biomaterials, *Tomar, Portugal*. Engineering Conf. Intl., 6 Metro Tech Ctr., Brooklyn, NY 11201; 212-591-8144; fax 212-591-8145; e-mail bhconf@poly.edu; www.engconfintl.org/3ay.html.

18-20 Conf. on Magnesium Alloys and Their Applications, *Wolfsburg, Germany*. M. Schmieder, MatInfo GmbH, Hamburger Allee 26, 60486 Frankfurt, Germany; 49-69-7917-756; fax 49-69-7917-733; e-mail expo@dgm.de; www.dgm.de/magnesium.

30-3 Copper Conf., *Santiago, Chile*. G. Lagos, Pontificia Univ. Catolica de Chile, Dept. de Ingenieria Quimica, Vicuna Mackenna 4860, Santiago 6904411, Chile; 56-2-686-5927; fax 56-2-686-5805; e-mail inf@cu2003.cl.

DECEMBER 2003

1-5 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

JANUARY 2004

5-10 ▼ Winter Conf. on Plasma Spectrochemistry, *Ft. Lauderdale, FL*. R. Barnes, ICP Information Newsletter, P.O. Box 666, Hadley, MA 01003-0666; 413-256-8942; fax 413-256-3746; e-mail winterconf@chem.umass.edu; www.chem.umass.edu/WinterConf2004.

MARCH 2004

14-18 TMS Annual Meeting, *Charlotte, NC*. Programming Dept., The Minerals, Metals & Materials Society, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail raabe@tms.org; www.tms.org.

APRIL 2004

12-16 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

18-21 106th ACerS Meeting, *Indianapolis, IN*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org.

MAY 2004

9-14 205th Meeting of the Electrochemical Society, *San Antonio, TX*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

16-21 ▼ 7th World Biomaterials Congress, *Sydney, Australia*. Biomaterials Congress Managers, GPO Box 128, Sydney NSW 2001, Australia; 61-2-9262-2277; fax 61-2-9262-3135; e-mail biomaterials@tourhosts.com.au; www.tourhosts.com.au/biomaterials.

24-28 E-MRS Spring Meeting, *Strasbourg, France*. European Materials Research Society, 23 rue du Loess, B.P. 20, 67037 Strasbourg Cedex 02, France; 33-3-88-10-6372; 33-3-88-10-6293; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr. **E-MRS.**

JULY 2004

11-15 ▼ 9th Intl. Conf. on the Structure of Non-Crystalline Materials, *Corning and Alfred, NY*. A.N. Cormack, New York State College of Ceramics at Alfred Univ., 2 Pine St., Alfred, NY 14802; 607-871-2980; e-mail cormack@alfred.edu; nyscc.alfred.edu/NCM9.

SEPTEMBER 2004

12-15 5th Intl. Conf. on High Temperature Ceramic Matrix Composites, *Seattle, WA*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org.

OCTOBER 2004

3-8 206th Meeting of the Electrochemical Society, *Honolulu, HI*. The Electrochemical Society, 65 S. Main St., Bldg. D, Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/meetings.htm.

NOVEMBER 2004

14-16 37th IMAPS Annual Symposium on Microelectronics, *Long Beach, CA*. IMAPS, 611 2nd St., N.E., Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

15-19 51st AVS Intl. Symposium, *Anaheim, CA*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@avs.org; www.avs.org.

29-3 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.** □